

Amendment to the Specification

Please replace the title with the new title "FLAT PANEL DISPLAY ARRANGEMENT WITH GROUNDED PCB"

Please replace paragraph [0008] of the published patent application 2004/0257515 A1 with the following amended paragraph:

[0008] ~~As a method~~ Methods of bonding an LCD driver IC (integrated chip) to the TFT array substrate, ~~there are~~ include a TAB (tape automated bonding) method, a COG (chip on glass) method, etc.